SH7216 Group

Using the Multi-function Timer Pulse Unit 2, A/D Converter and Direct Memory Access Controller

REJ06B1002-0100
Rev. 1.00
Jun. 03, 2010

Summary

This application note provides an example to use the SH7216 Multi-function Timer Pulse Unit 2, A/D Converter, and Direct Memory Access Controller.

Target Device

SH7216 MCU

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1. Introduction

1.1 Specifications

The SH7216 Multi-function Timer Pulse Unit 2 activates the A/D Converter, and SH7216 Direct Memory Access Controller transfers the A/D conversion value to the SH7216 on-chip RAM.

1.2 Modules Used

- Multi-function Timer Pulse Unit 2
- A/D Converter
- Direct Memory Access Controller

1.3 Applicable Conditions

MCU	SH7216
Operating Frequencies	Internal clock: 200 MHz Bus clock: 50 MHz Peripheral clock: 50 MHz AD clock: 50 MHz
Integrated Development Environment	Renesas Electronics Corporation High-performance Embedded Workshop Ver.4.07.00
C Compiler	Renesas Electronics SuperH RISC engine Family C/C++ Compiler Package Ver.9.03 Release 00
Compiler Options	Default setting in the High-performance Embedded Workshop (-cpu=sh2afpu -fpu=single -debug -gbr=auto -global_volatile=0 -opt_range=all -infinite_loop=0 -del_vacant_loop=0 -struct_alloc=1)

1.4 Related Application Note

For more information, refer to the following application note:

- SH7216 Group Example of Initialization

2. Applications

2.1 Overview of Modules

2.1.1 Multi-function Timer Pulse Unit 2

The Multi-function Timer Pulse Unit 2 is an advanced timer unit, consisting of six 16-bit timer channels. The compare match function, and input capture function can be specified on each channel of the Multi-function Timer Pulse Unit 2. Set channels 3 and 4 of the Multi-function Timer Pulse Unit 2 in reset-synchronized PWM mode or complementary PWM mode to control 6-phase PWM output. Also, use the compare match or input capture as triggers to activate the Direct Memory Access Controller, Data Transfer Controller, and A/D Converter directly, not via the CPU.

Table 1 lists the specifications of the Multi-function Timer Pulse Unit 2. Figure 1 shows its block diagram. For more information, refer to the Multi-function Timer Pulse Unit 2 (MTU2) chapter in the SH7216 Group Hardware Manual.

Table 1 Multi-function Timer Pulse Unit 2 Specifications

Item	Description
Number of channels	16-bit timer × 6 channels (channels 0 to 5)
Counter clock	Internal clock or external clock can be used on each channel Note: Only the internal clock can be specified on channel 5.
Channels 0 to 5 operation	• Outputs waveforms by compare match, and input capture • Clears counter, writes to multiple timer counters (TCNT) simultaneously, clears counter simultaneously by compare match and input capture • Synchronized inputs to or from registers by counter synchronization, and 12-phase PWM waveform outputs (max.) by using with synchronization
A/D converter start trigger	• A/D converter start trigger can be generated • In complementary PWM mode, interrupts at the crest and trough of the counter value and A/D converter start triggers can be skipped
Buffer operation	Register buffer operation can be specified on channels 0, 3, and 4
Operating mode	• Channels 0 to 4: PWM mode can be specified • Channels 1 and 2: Phase counting mode can be specified, respectively • Channels 3 and 4 (interlocked): Outputting six-phase PWM waveforms (three-phase positive and three-phase negative) in complementary PWM and reset-synchronized PWM modes can be specified
Interrupt request	28 interrupt sources (e.g. Compare match interrupt, input capture interrupt)
Other	• Cascade connection • Module standby mode can be specified • Dead time compensation counter available by channel 5

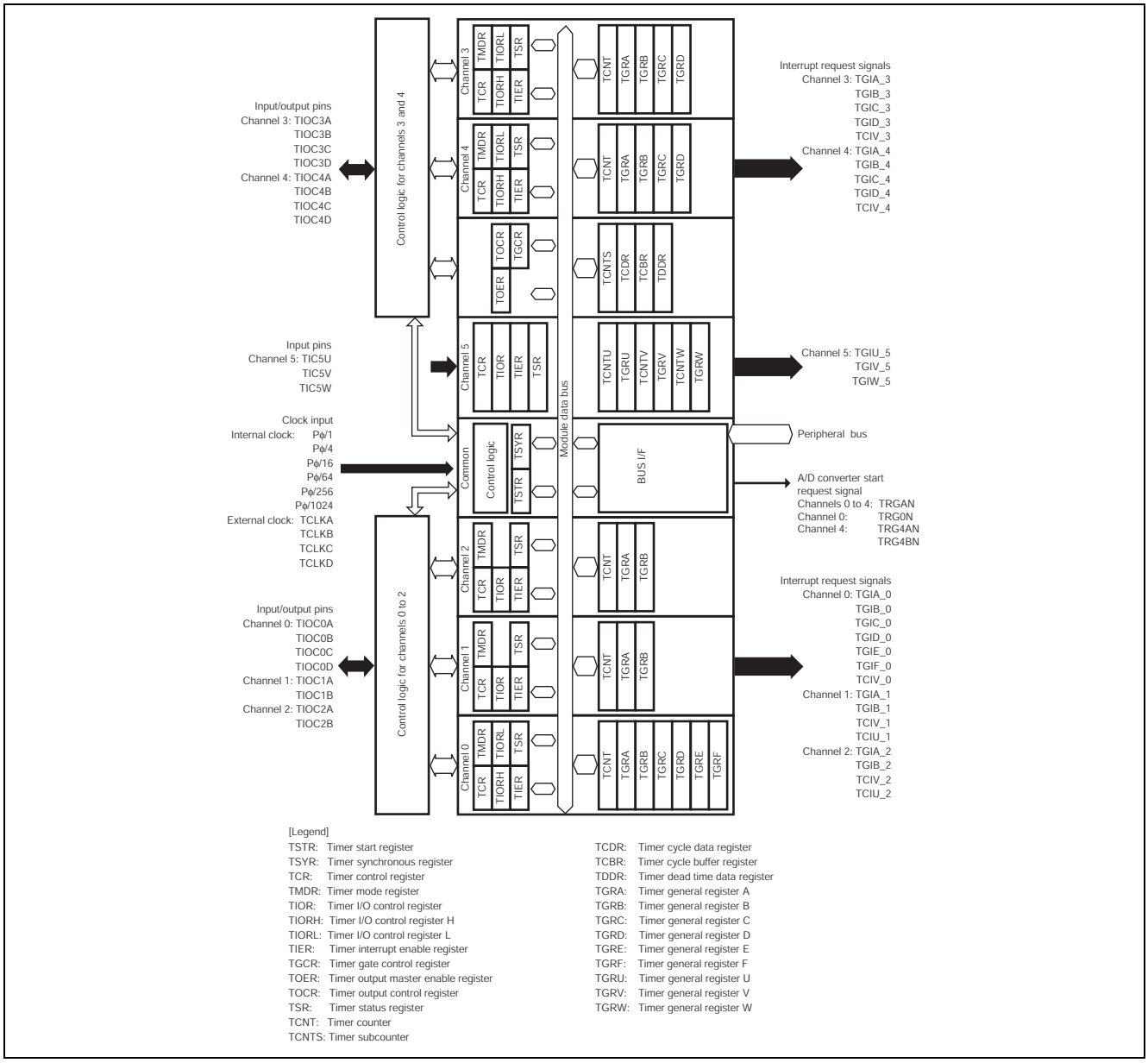

Figure 1 Multi-function Timer Pulse Unit 2 Block Diagram

2.1.2 A/D Converter

The A/D Converter includes two A/D modules (A/D_0 and A/D_1) to input four channels with 12-bit resolution. Data converted by the A/D Converter is stored in the A/D data register (ADDR).

A/D Converter operates in single-cycle scan mode, and continuous scan mode. In single-cycle scan mode, the A/D Converter converts the input analog voltage to digital on one or more channels specified, and enters the A/D conversion wait state. In continuous scan mode, the A/D Converter converts the input analog voltage to digital repeatedly on one or more channels specified. When converting analog to digital is completed, the A/D conversion end interrupt can be generated to the CPU. The Direct Memory Access Controller and Data Transfer Controller can be activated when the A/D conversion end interrupt occurs (note).

Table 2 lists the A/D Converter specifications. Figure 2 shows its block diagram. For more information, refer to the A/D Converter (ADC) chapter in the SH7216 Group Hardware Manual.

Note: When the Direct Memory Access Controller is activated, the CPU interrupt is not generated. The Direct Memory Access Controller can only be activated by A/D module_0 (A/D_0).

Table 2 A/D Converter Specifications

Item	Description
Resolution	12-bit
Conversion speed	Minimum conversion timer per channel: 1.0 µs (Aφ is operating at 50 MHz)
Number of modules	2 (A/D_0, A/D_1)
Number of input channels	8 (AN0 to AN7)
Operating mode	• Single-cycle scan mode • Continuous scan mode
Sample-and-hold function	• Channels 0 to 3 share one circuit, channels 4 to 7 share one circuit • Channels 0 to 2 have dedicated circuits for each channel (3 circuits in total)
A/D conversion trigger	• Software: ADST bit setting • Timer: — TRGAN, TRG0N, TRG4AN, and TRG4BN from the Multi-function Timer Pulse Unit 2 — TRGAN, TRG4AN, and TRG4BN from the Multi-function Timer Pulse Unit 2 • External trigger: $\overline{\text{ADTRG}}$

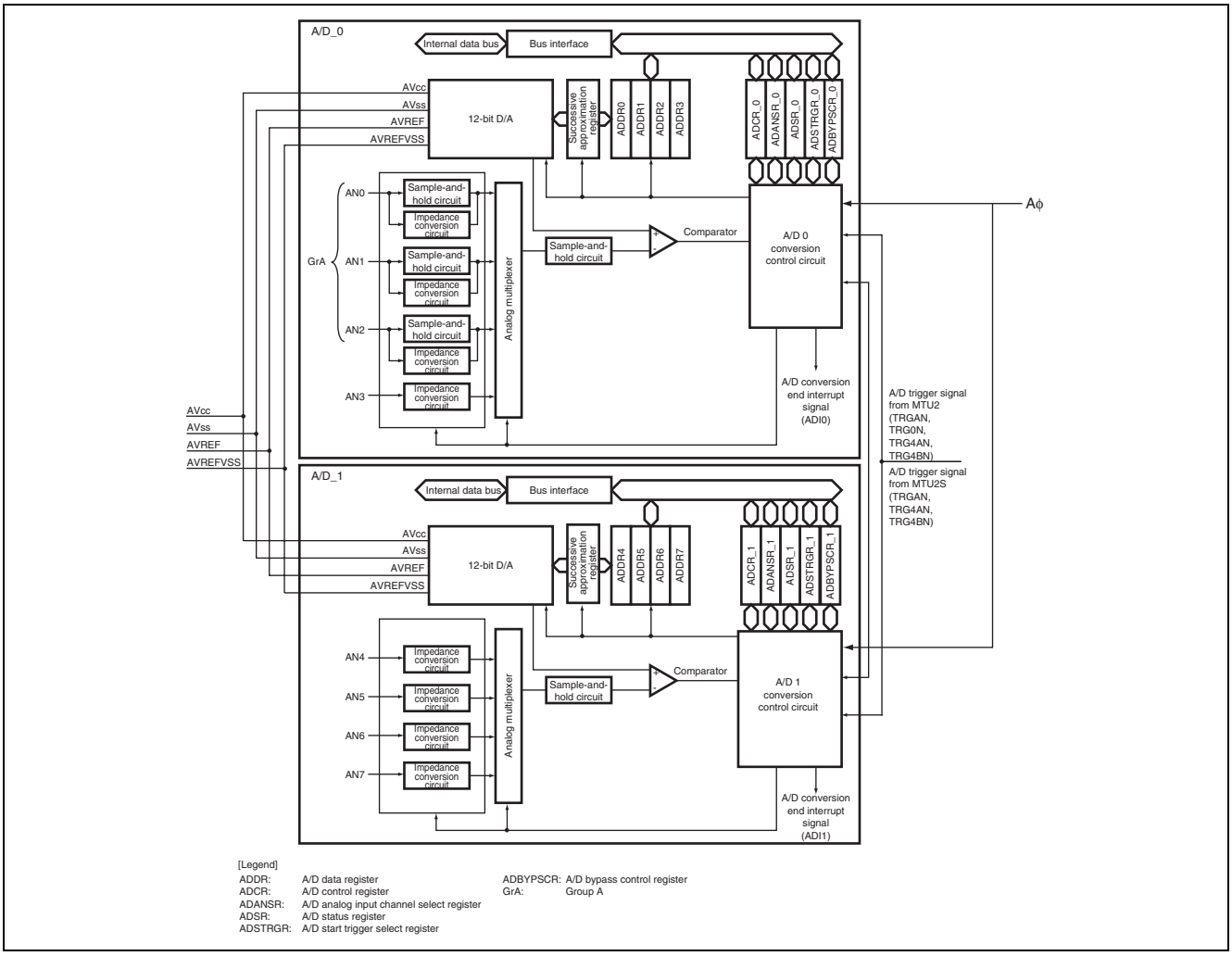

Figure 2 A/D Converter Block Diagram

2.1.3 Direct Memory Access Controller

The Direct Memory Access Controller transfers data among the external device with DACK (transfer request acknowledge signal), external memory, on-chip memory, memory-mapped external device, and on-chip peripheral modules, instead of CPU. It has two bus modes; cycle steal mode and burst mode.

In cycle steal mode, the Direct Memory Access Controller leaves the bus to the other masters when it finishes "a transmit" (in bytes, words, long words, or 16 bytes). When the Direct Memory Access Controller receives another transfer request, it retrieves the bus again. Then, it transfers data in unit of a transfer, and leaves the bus again to the other bus. The Direct Memory Access Controller repeats this operation until the transfer end conditions are satisfied.

The Direct Memory Access Controller can generate the DMA transfer end interrupt to the CPU when the DMA transfer is completed.

Table 3 lists the Direct Memory Access Controller specifications. Figure 3 shows its block diagram. For more information, refer to the Direct Memory Access Controller (DMAC) chapter in the SH7216 Group Hardware Manual.

Table 3 Direct Memory Access Controller Specifications

Item	Description
Number of channels	8 (Channels 0 to 7)
Address space	4 GB physically
Transfer data length	Byte, word (2 bytes), long word (4 bytes), and 16 bytes (4 long words)
Number of transfers	16,777,216 (24-bit) times
Address mode	• Single address mode • Dual address mode
Transfer request	• Auto-request • External request (Only 4 channels, channels 0 to 3) • On-chip peripheral module request (number of requests: 19)
Bus mode	• Cycle steal mode • Burst mode
Interrupt source	CPU interrupt is generated when one-half of the data transfer ("a transfer") is completed or "a transfer" is completed
External request detection	DREQ (Transfer request signal from an external device) input can be detected in low level or high level, and at rising edge or falling edge
DMA transfer request acknowledge signal/DMA transfer end	Active levels for DACK and TEND signals can be specified
Reload function	The reload function can be enabled or disabled per channel

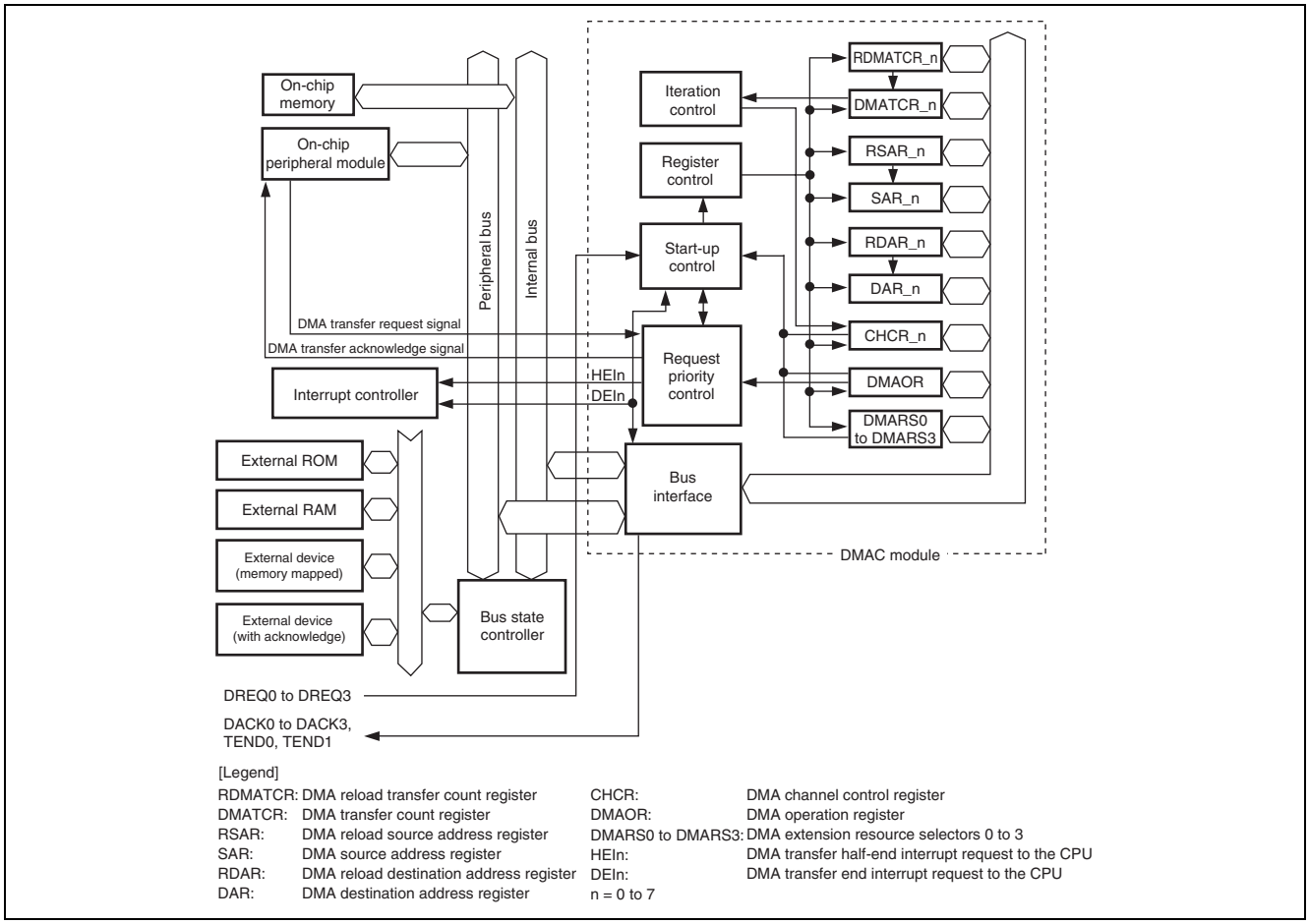

Figure 3 Direct Memory Access Controller Block Diagram

2.2 Configuration Procedure

2.2.1 Configuring the Multi-function Timer Pulse Unit 2

Figure 4 shows the flow chart for configuring the Multi-function Timer Pulse Unit 2 used in this application. For more information on register settings, refer to the SH7216 Group Hardware Manual.

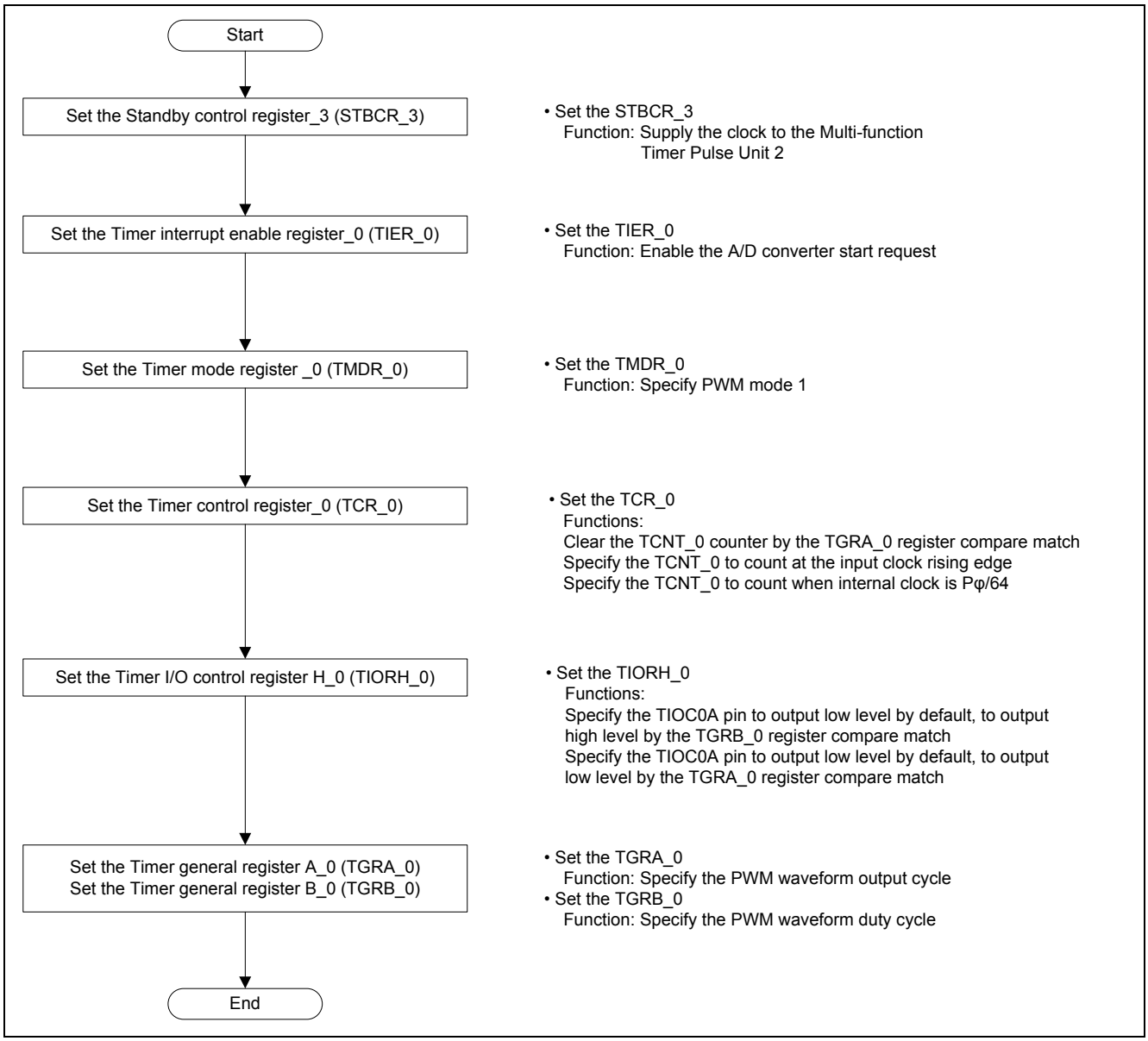

Figure 4 Flow Chart for Configuring the Multi-function Timer Pulse Unit 2

2.2.2 Configuring the A/D Converter

Figure 5 shows the flow chart for configuring the A/D Converter used in this application. For more information on register settings, refer to SH7216 Group Hardware Manual.

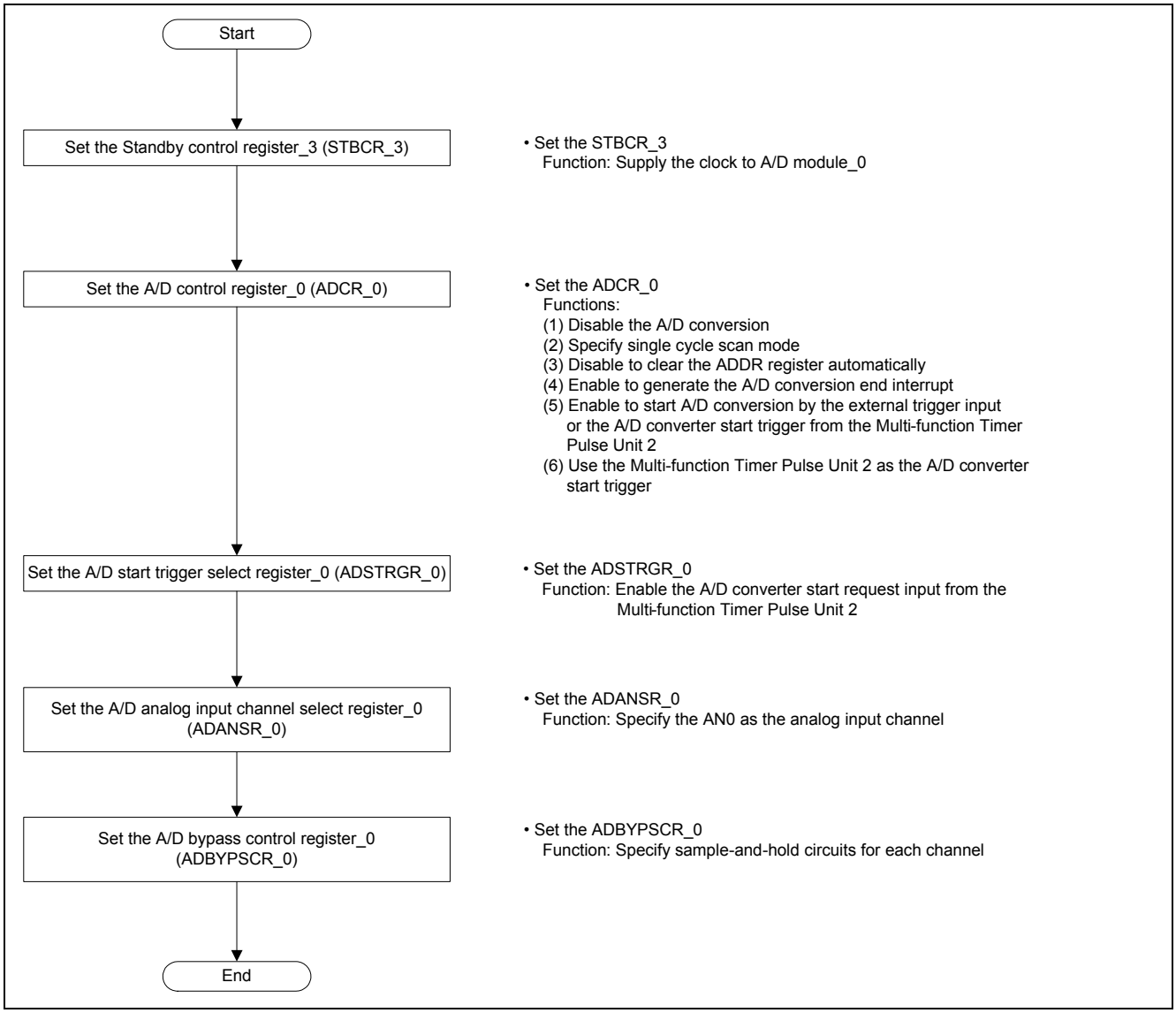

Figure 5 Flow Chart for Configuring the A/D Converter

2.2.3 Configuring the Direct Memory Access Controller

Figure 6 shows the flow chart for configuring the Direct Memory Access Controller used in this application. For more information on register settings, refer to the SH7216 Group Hardware Manual.

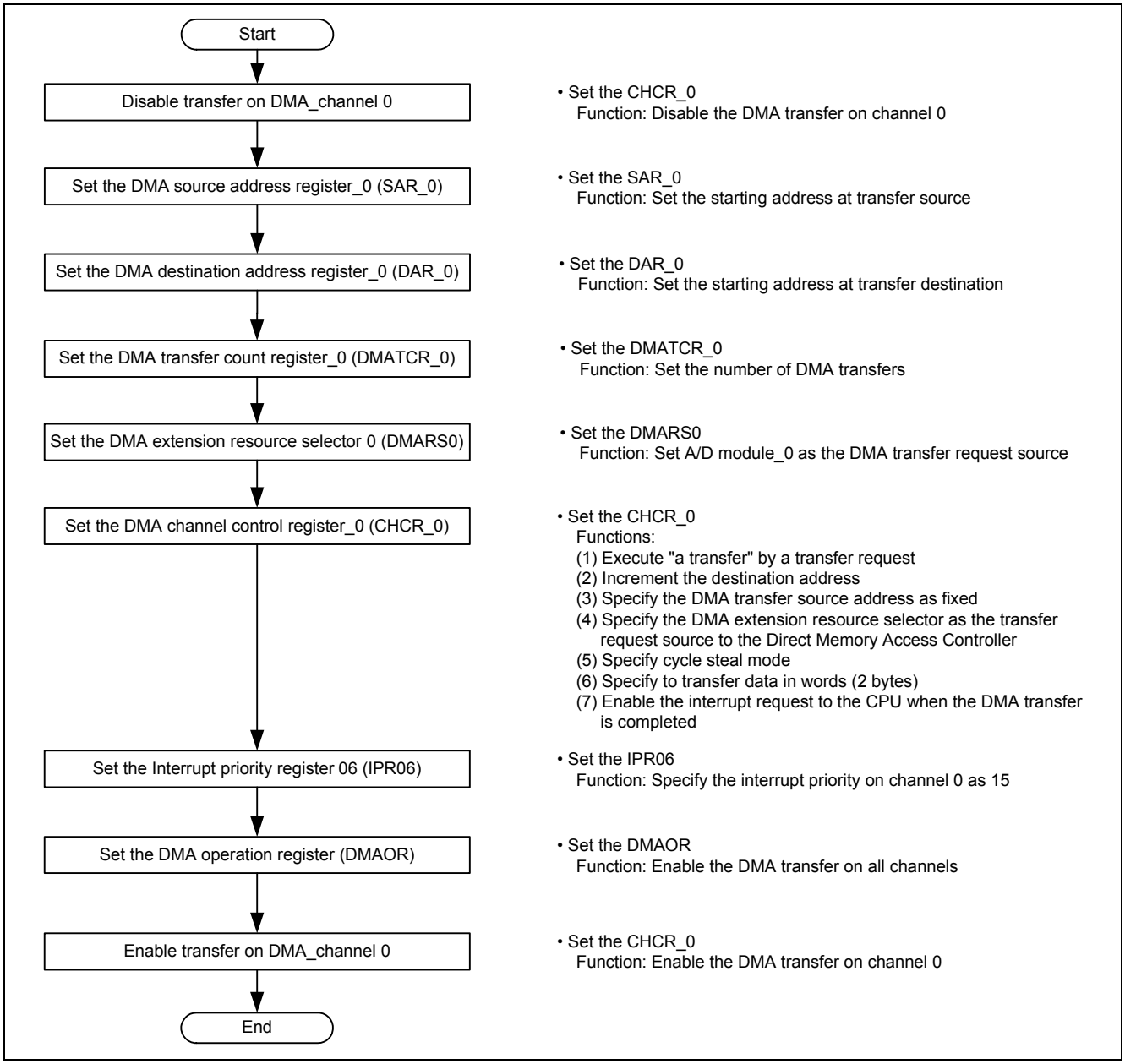

Figure 6 Flow Chart for Configuring the Direct Memory Access Controller

2.3 Sample Program Procedure

2.3.1 Sample Program Operation

The sample program uses the Multi-function Timer Pulse Unit 2 to output PWM waveform (one cycle is 1 ms), and activates the A/D Converter in every cycle. Then, it transfers the A/D conversion value to on-chip RAM by the Direct Memory Access Controller every time the A/D conversion is completed.

The Multi-function Timer Pulse Unit 2 operates in PWM mode 1, and outputs PWM waveform (duty cycle = 50%, one cycle = 1 ms) from the TIOC0A pin. It specifies the cycle in Timer general register A_0 (TGRA_0), and the duty cycle in Timer general register B_0. The A/D converter start request signal (TRGAN) occurs on the compare match between Timer counter_0 (TCNT_0) and TGRA_0 (note).

The A/D Converter operates in single scan mode to start the A/D conversion on the analog input channel AN0 by the TRGAN. The A/D conversion end interrupt signal (ADI0) occurs when the A/D conversion is completed.

The Direct Memory Access Controller operates in cycle steal mode to transfer the A/D conversion data from A/D data register 0 (ADDR0) to on-chip RAM by ADI0. The DMA transfer end interrupt (DEI) occurs when transferring 1-KB data is completed.

After the CPU is reset, the sample program configures the A/D Converter, Direct Memory Access Controller, and Multi-function Timer Pulse Unit 2, and starts TCNT_0 counter. Then, it executes the A/D conversion on every TGRA_0 compare match, and transfers the A/D conversion value to on-chip RAM by the Direct Memory Access Controller. In the DMA transfer end interrupt processing, the sample program disables the DMA transfer, clears the transfer end flag (TE bit), and stops TCNT_0 counter.

Figure 7 shows the sample program operation (overview).

Note: The A/D converter start request can be generated no matter whether the Multi-function Timer Pulse Unit 2 outputs PWM waveforms or not.

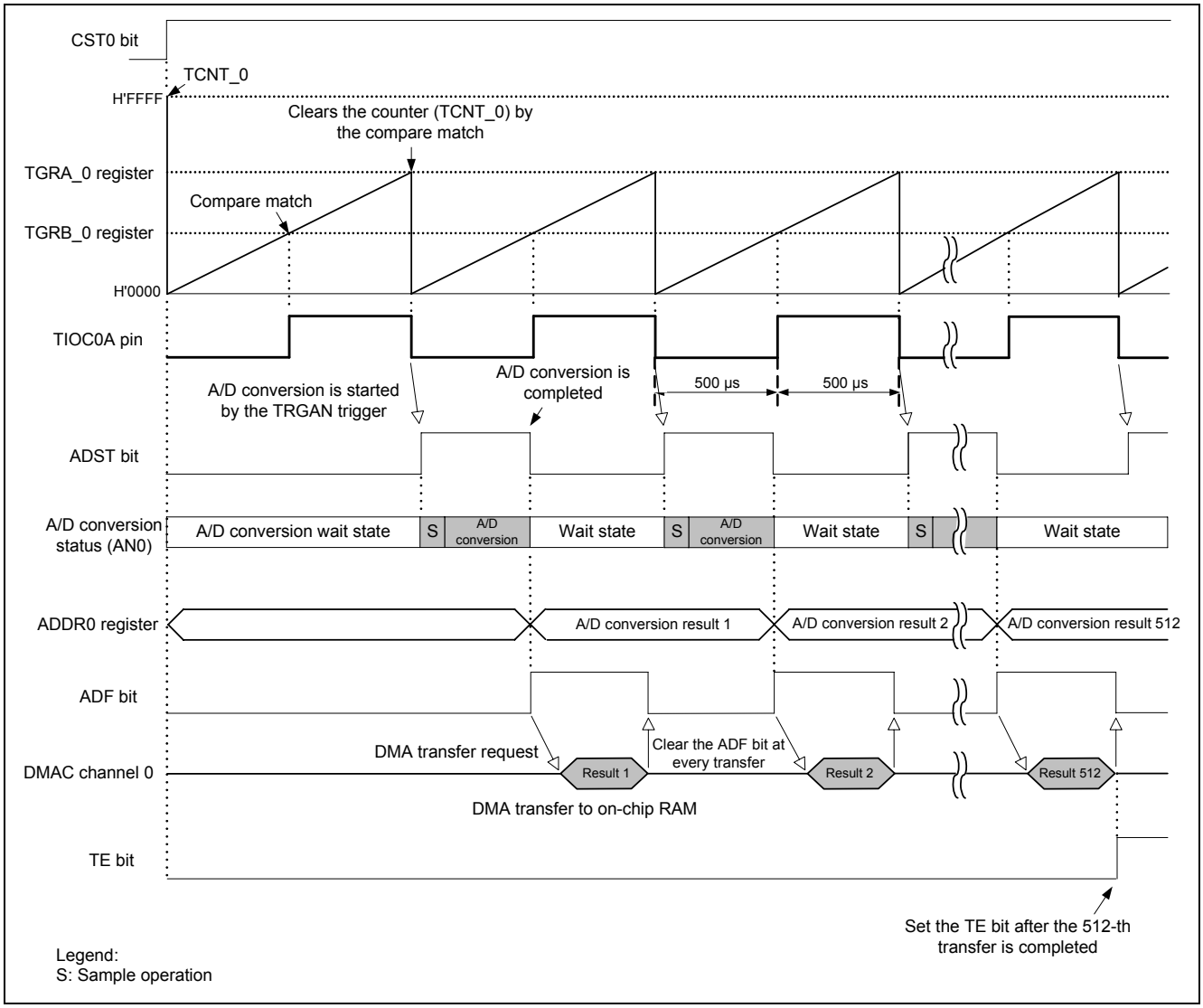

Figure 7 Sample Program Operation (Overview)

2.3.2 Multi-function Timer Pulse Unit 2 Register Setting

Table 4 lists the register settings for the Multi-function Timer Pulse Unit 2.

Table 4 Multi-function Timer Pulse Unit 2 Register Settings

Register Name	Address	Setting	Description
Standby control register 3 (STBCR3)	H'FFFE 0408	H'5A	• MSTP35 = "0": Supply the clock to the Multi-function Timer Pulse Unit 2
Port E control register L1 (PECRL1)	H'FFFE 3A16	H'0004	• PE0MD = "4": Specify PE0 pin as the TIOC0A
Port E I/O register L (PEIORL)	H'FFFE 3A06	H'0001	• PE0IOR = "1": Specify the TIOC0A to output
Timer control register_0 (TCR_0)	H'FFFE 4300	H'23	• CCLR[2:0] = "B'001": Clear TCNT_0 by TGRA_0 compare match or input capture • CKEG[1:0] = "B'00": Specify TCNT_0 to count at rising edge of the input clock • TPSC[2:0] = "B'011": Specify TCNT_0 to count when internal clock is Pφ/64
Timer I/O control register H_0 (TIORH_0)	H'FFFE 4302	H'21	• IOB[3:0] = "B'0010": Specify to output low level signal by default, to output high level signal by the compare match • IOA[3:0] = "B'0001": Specify to output low level signal by default, to output low level signal by the compare match
Timer interrupt enable register_0 (TIER_0)	H'FFFE 4304	H'80	• TTGE = "1": Enable to generate the A/D converter start request
Timer general register A_0 (TGRA_0)	H'FFFE 4308	D'781	Specify the PWM waveform output cycle
Timer general register B_0 (TGRB_0)	H'FFFE 430A	D'390	Specify the PWM waveform duty cycle
Timer mode register_0 (TMDR_0)	H'FFFE 4301	H'02	• MD[3:0] = "B'0010": Specify PWM mode 1
Timer start register (TSTR)	H'FFFE 4280	H'01	• CST0 = "1": TCNT_2 to TCNT_0 counters are running

2.3.3 A/D Converter Register Setting

Table 5 lists the register settings for the A/D Converter.

The following setting enables the A/D conversion end interrupt, however, the CPU interrupt is not generated because the Direct Memory Access Controller is activated in this application.

Table 5 A/D Converter Register Settings

Register Name	Address	Setting	Description
Standby control register 3 (STBCR3)	H'FFFE 0408	H'5A	• MSTP32 = "0": Supply the clock to A/D_0
A/D control register_0 (ADCR_0)	H'FFFF E800	H'12	• ADST = "0": Disable the A/D conversion • ADCS = "0": Specify single-cycle scan mode • ACE = "0": Disable to clear the ADDR register automatically by reading the ADDR register • ADIE = "1": Enable to generate the A/D conversion end interrupt • TRGE = "1": Enable the A/D conversion by the external trigger input or the A/D converter start trigger from the Multi-function Timer Pulse Unit 2 • EXTRG = "0": Activate the A/D Converter by the A/D converter start trigger from the Multi-function Timer Pulse Unit 2
A/D start trigger select register_0 (ADSTRGR_0)	H'FFFF E81C	H'04	• STR2 = "1": Enable to start the A/D conversion by the TRGAN trigger (Multi-function Timer Pulse Unit 2)
A/D analog input channel select register_0 (ADANSR_0)	H'FFFF E820	H'01	• ANS0 = "1": Specify the analog input channel AN0
A/D bypass control register_0 (ADBYPSCR_0)	H'FFFF E830	H'01	• SH = "1": Specify the exclusive sample-and-hold circuit for each channel

2.3.4 Direct Memory Access Controller Register Setting

Table 6 lists the register settings for the Direct Memory Access Controller.

Table 6 Direct Memory Access Controller Register Settings

Register Name	Address	Setting	Description
DMA source address register_0 (SAR_0)	H'FFFE 1000	H'FFFF E840	Transfer source address: ADDR0 register address
DMA destination address register_0 (DAR_0)	H'FFFE 1004	H'FFF8 0000	Transfer destination address: Starting address in on-chip RAM (Transfer destination)
DMA transfer count register_0 (DMATCR_0)	H'FFFE 1008	D'512	Number of transfers: 512
DMA channel control register_0 (CHCR_0)	H'FFFE 100C	H'0000 0000	• DE = "0": Disable the DMA transfer
		H'0000 480C	• TC = "0": Execute "a transfer" by a DMA transfer request • RLD = "0": Disable the reload function • DM[1:0] = "B'01": Increment the destination address by two • SM[1:0] = "B'00": Specify the source address as fixed • RS[3:0] = "B'1000": Specify the DMA extension resource selector • TB = "0": Specify cycle steal mode • TS[1:0] = "B'01": Specify to transfer data in words • IE = "1": Enable the interrupt request
		H'0000 580D	• DE = "1": Enable the DMA transfer on channel 0
DMA operation register (DMAOR)	H'FFFE 1200	H'0007 (note)	• DME = "1": Enable the DMA transfer on all channels
DMA extension resource selector 0 (DMARS0)	H'FFFE 1300	H'00B3	• CH0 MID[5:0] = "B'1011 00": • CH0 RID[1:0] = "B'11": Specify A/D module_0 as the DMA transfer request source
Interrupt priority register 06 (IPR06)	H'FFFE 0C00	H'F000	Transfer end interrupt level: 15

Note: To avoid clearing the address error flag and NMI flag, the above setting writes 1 in bits AE and NMIF.

2.3.5 Sample Program Flow Chart

Figure 8 shows the flow chart of the sample program.

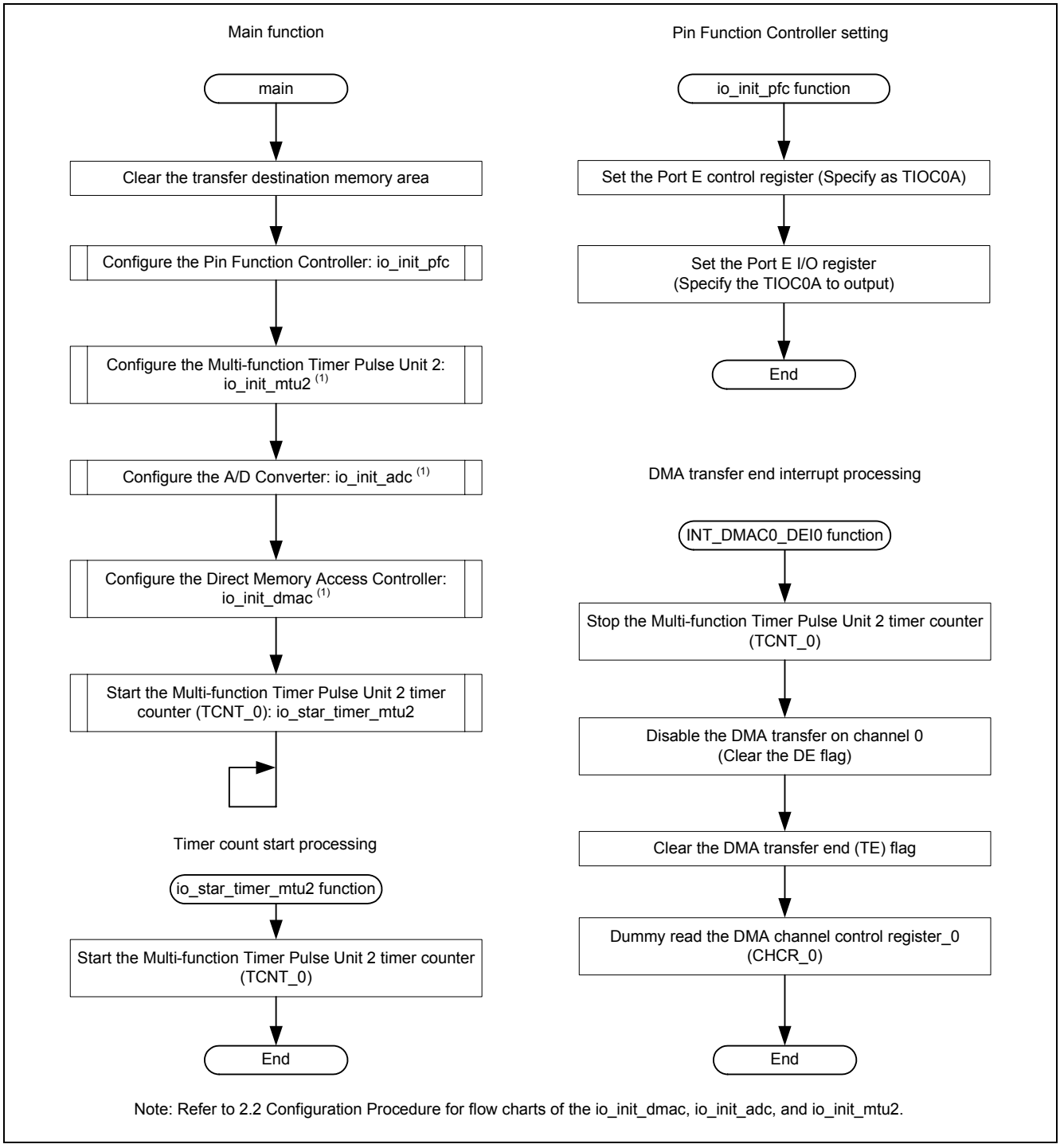

Figure 8 Sample Program Flow Chart

3. Sample Program Listing

3.1 Sample Program List "main.c" (1/9)

```
1   /***********************************************************************
2   *   DISCLAIMER
3   *
4   *   This software is supplied by Renesas Electronics Corp. and is only
5   *   intended for use with Renesas products.  No other uses are authorized.
6   *
7   *   This software is owned by Renesas Electronics Corp. and is protected under
8   *   all applicable laws, including copyright laws.
9   *
10  *   THIS SOFTWARE IS PROVIDED "AS IS" AND RENESAS MAKES NO WARRANTIES
11  *   REGARDING THIS SOFTWARE, WHETHER EXPRESS, IMPLIED OR STATUTORY,
12  *   INCLUDING BUT NOT LIMITED TO WARRANTIES OF MERCHANTABILITY, FITNESS FOR A
13  *   PARTICULAR PURPOSE AND NON-INFRINGEMENT.  ALL SUCH WARRANTIES ARE EXPRESSLY
14  *   DISCLAIMED.
15  *
16  *   TO THE MAXIMUM EXTENT PERMITTED NOT PROHIBITED BY LAW, NEITHER RENESAS
17  *   ELECTRONICS CORP. NOR ANY OF ITS AFFILIATED COMPANIES SHALL BE LIABLE
18  *   FOR ANY DIRECT, INDIRECT, SPECIAL, INCIDENTAL OR CONSEQUENTIAL DAMAGES
19  *   FOR ANY REASON RELATED TO THIS SOFTWARE, EVEN IF RENESAS OR ITS
20  *   AFFILIATES HAVE BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.
21  *
22  *   Renesas reserves the right, without notice, to make changes to this
23  *   software and to discontinue the availability of this software.
24  *   By using this software, you agree to the additional terms and
25  *   conditions found by accessing the following link:
26  *   http://www.renesas.com/disclaimer
27  ***********************************************************************
28  *   (C) 2010 Renesas Electronics Corporation. All rights reserved.
29  *""FILE COMMENT""*********** Technical reference data *********************
30  *   System Name : SH7216 Sample Program
31  *   File Name   : main.c
32  *   Abstract    : MTU2+ADC+DMAC Module Application
33  *   Version     : 1.00.00
34  *   Device      : SH7216
35  *   Tool-Chain  : High-performance Embedded Workshop (Ver.4.07.00).
36  *               : C/C++ compiler package for the SuperH RISC engine family
37  *               :                             (Ver.9.03 Release00).
38  *   OS          : None
39  *   H/W Platform: R0K572167 (CPU board)
40  *   Description :
41  ***********************************************************************
42  *   History     : Jun.03,2010 Ver.1.00.00
43  *""FILE COMMENT END""*****************************************************/
44  #include "iodefine.h"
45
46  /* ==== Macro definition ==== */
47  #define DMA_SRC_ADR    0xffffe840     /* DMA transfer source (ADDR0) address */
48  #define DMA_COUNT  512            /* Number of transfers: 512 (1 word/1 transfer) */
49
```

3.2 Sample Program List "main.c" (2/9)

```
50    /* ==== Prototype declaration ==== */
51    void main(void);
52    void io_init_pfc(void);
53    void io_init_mtu2(void);
54    void io_init_adc(void);
55    void io_init_dmac(void *src, void *dst, int count);
56    void io_start_timer_mtu2(void);
57
58    /* ==== Global variable ==== */
59    unsigned short ad_data[DMA_COUNT];    /* Transfer destination of the A/D conversion data */
60    volatile unsigned char f_dma_end; /* Variable to check if the DMA transfer is completed */
61
62    /*""FUNC COMMENT""*****************************************************************
63     * ID            :
64     * Outline       : Sample program main
65     *-------------------------------------------------------------------------------
66     * Include       :
67     *-------------------------------------------------------------------------------
68     * Declaration   : void main(void);
69     *-------------------------------------------------------------------------------
70     * Description   : Clears the DMA transfer destination, configures the PFC,
71     *               : MTU2, ADC and DMAC.
72     *               : Then, this function starts the MTU2 timer to count.
73     *               : After counting is started, it outputs PWM waveform in 1-ms
74     *               : cycle, and activates the ADC in every cycle.
75     *               : It transfers the A/D conversion value to on-chip RAM every
76     *               : time the A/D conversion is completed.
77     *               : After the timer starts counting, this function waits until
78     *               : transferring 1-KB data is completed.
79     *-------------------------------------------------------------------------------
80     * Argument      : void
81     *-------------------------------------------------------------------------------
82     * Return Value  : void
83     *-------------------------------------------------------------------------------
84     * Note          : None
85     *""FUNC COMMENT END""*************************************************************/
86    void main(void)
87    {
88      int i;                      /* Loop counter variable */
89
90      /* ==== Clears the transfer destination memory area ==== */
91      for(i = 0; i < DMA_COUNT; i++){
92        ad_data[i] = 0x0000;      /* Clears the area storing A/D conversion data */
93                                  /* in on-chip RAM to 0 */
94      }
95
96      /* ==== Configures the PFC ==== */
97      io_init_pfc();
98
```

3.3 Sample Program List "main.c" (3/9)

```
99        /* ==== Configures the MTU2 ==== */
100       io_init_mtu2();
101
102       /* ==== Configures the ADC ==== */
103       io_init_adc();
104
105       /* ==== Configures the DMAC ==== */
106       io_init_dmac((void *)DMA_SRC_ADR, (void *)ad_data, DMA_COUNT);
107
108       /* ==== Specifies the MTU2 timer (TCNT_0) to start counting ==== */
109       io_start_timer_mtu2();
110
111       while(f_dma_end == 0){
112         /* Waits until the DMA transfer is completed */
113       }
114
115       while(1){
116         /* loop */
117       }
118     }
119
120     /*""FUNC COMMENT""*****************************************************************
121      * ID            :
122      * Outline       : PFC configuration
123      *-----------------------------------------------------------------------------
124      * Include       : "iodefine.h"
125      *-----------------------------------------------------------------------------
126      * Declaration   : void io_init_pfc(void);
127      *-----------------------------------------------------------------------------
128      * Description   : Configures the Pin Function Controller (PFC).
129      *               : Specifies the PE0 pin function to TIOC0A output.
130      *-----------------------------------------------------------------------------
131      * Argument      : void
132      *-----------------------------------------------------------------------------
133      * Return Value  : void
134      *-----------------------------------------------------------------------------
135      * Note          : None
136      *""FUNC COMMENT END""*************************************************************/
137     void io_init_pfc(void)
138     {
139       /* ==== Sets the Port E control register L1 (PECRL1) ==== */
140       PFC.PECRL1.BIT.PE0MD = 4;   /* Sets the PE0 pin function to TIOC0A */
141
142       /* ==== Sets the Port E IO register L (PEIORL) ==== */
143       PFC.PEIORL.BIT.B0 = 1;      /* Sets the TIOC0A pin to output */
144     }
145
```

3.4 Sample Program List "main.c" (4/9)

```
/*""FUNC COMMENT""*****************************************************************
 * ID            :
 * Outline       : MTU2 configuration
 *-----------------------------------------------------------------------------
 * Include       : "iodefine.h"
 *-----------------------------------------------------------------------------
 * Declaration   : void io_init_mtu2(void);
 *-----------------------------------------------------------------------------
 * Description   : Configures the Multi-function Timer Pulse Unit 2 (MTU2).
 *               :  - Operating mode: PWM mode 1
 *               :  - TCNT_0: Count when the internal clock is P-clock/64
 *               :  - PWM waveform cycle: Set to TGRA_0
 *               :  - PWM waveform duty cycle: Set to TGRB_0
 *-----------------------------------------------------------------------------
 * Argument      : void
 *-----------------------------------------------------------------------------
 * Return Value  : void
 *-----------------------------------------------------------------------------
 * Note          : None
 *""FUNC COMMENT END""*************************************************************/
void io_init_mtu2(void)
{
  /* ==== Sets the Standby control register (STBCR3) ==== */
  STB.CR3.BIT._MTU2 = 0;      /* Supplies the clock to the MTU2 */

  /* ==== Sets the Timer interrupt enable register_0 (TIER_0) ==== */
  MTU20.TIER.BIT.TTGE = 1;    /* Enables the A/D converter start request */

  /* ==== Sets the Timer control register_0 (TCR_0) ==== */
  MTU20.TCR.BYTE = 0x23;
    /*
        bit 7 to 5: CCLR[2:0] = B'001 --- Clears the Timer counter (TCNT) by the
                  :                       Timer general register (TGRA) compare match
        bit 4, 3: CKEG[1:0] = B'00 ------ Specifies the TCNT to count at the
                :                         rising edge of the input clock
        bit 2 to 0: TPSC[2:0] = B'011 --- Specifies the TCNT to count when
                  :                       the internal clock is P-clock/64
     */

```

3.5 Sample Program List "main.c" (5/9)

```
185      /* ==== Sets the Timer I/O control register H_0 (TIORH_0) ==== */
186      MTU20.TIOR.BIT.IOB = 2;     /* TIOC0A pin outputs low level signal by default, */
187                                  /* outputs high level signal by the TGRB_0 register */
188                                  /* compare match */
189      MTU20.TIOR.BIT.IOA = 1;     /* TIOC0A pin outputs low level signal by default, */
190                                  /* outputs low level signal by the TGRA_0 register */
191                                  /* compare match */
192
193      /* ==== Sets the Timer general register A_0 (TGRA_0) ==== */
194      MTU20.TGRA = 782 - 1;       /* Specifies the PWM waveform 1-ms cycle by P-clock/64 */
195
196      /* ==== Sets the Timer general register B_0 (TGRB_0) ==== */
197      MTU20.TGRB = 391 - 1;       /* Specifies the PWM duty cycle 50% by P-clock/64 */
198
199      /* ==== Sets the Timer mode register_0 (TMDR_0) ==== */
200      MTU20.TMDR.BIT.MD = 2;      /* Specifies PWM mode 1 */
201    }
202
203    /*""FUNC COMMENT""*****************************************************************
204     * ID            :
205     * Outline       : ADC configuration
206     *-------------------------------------------------------------------------------
207     * Include       : "iodefine.h"
208     *-------------------------------------------------------------------------------
209     * Declaration   : void io_init_adc(void);
210     *-------------------------------------------------------------------------------
211     * Description   : Configures the A/D Converter (ADC).
212     *               :   - Operating mode: Single-cycle scan mode
213     *               :   - A/D converter start trigger: TRGAN (MTU2)
214     *               :   - Conversion circuit: Sample-and-hold circuit
215     *-------------------------------------------------------------------------------
216     * Argument      : void
217     *-------------------------------------------------------------------------------
218     * Return Value  : void
219     *-------------------------------------------------------------------------------
220     * Note          : None
221     *""FUNC COMMENT END""*************************************************************/
222     void io_init_adc(void)
223    {
224      /* ==== Sets the Standby control register 3 (STBCR3) ==== */
225      STB.CR3.BIT._ADC0 = 0;      /* Supplies the clock to A/D module_0 */
226
```

3.6 Sample Program List "main.c" (6/9)

```
227      /* ==== Sets the A/D control register_0 (ADCR_0) ==== */
228      ADC0.ADCR.BYTE = 0x12;
229        /*
230            bit 7: ADST = 0 ---- Not used
231            bit 6: ADCS = 0 ---- Single-cycle scan mode
232            bit 5: ACE = 0 ----- Disables to auto-clear the ADDR by reading the ADDR
233            bit 4: ADIE = 1 ---- Enables the A/D conversion end interrupt
234            bit 3, 2: Reserved(0)
235            bit 1: TRGE = 1 ---- Enables the A/D conversion by the external trigger or
236                 :               the A/D converter start trigger from the MTU2/MTU2S
237            bit 0: EXTRG = 0 --- Activates the A/D Converter by the A/D converter
238                 :               start trigger from the MTU2/MTU2S
239        */
240
241      /* ==== Sets the A/D start trigger select register_0 (ADSTRGR_0) ==== */
242      ADC0.ADSTRGR.BIT.STR2 = 1;  /* Enables to start the A/D conversion by the */
243                                   /* TRGAN trigger (MTU2) */
244
245      /* ==== Sets the A/D analog input channel select register_0 (ADANSR_0) ==== */
246      ADC0.ADANSR.BIT.ANS0 = 1;   /* Specifies the A/D analog input channel AN0 */
247
248      /* ==== Sets the A/D bypass control register_0 (ADBYPSCR_0) ==== */
249      ADC0.ADBYPSCR.BIT.SH = 1;   /* Specifies the sample-and-hold circuit */
250    }
251
```

3.7 Sample Program List "main.c" (7/9)

```
252    /*""FUNC COMMENT""*****************************************************************
253     * ID            :
254     * Outline       : DMAC configuration
255     *-----------------------------------------------------------------------------
256     * Include       : "iodefine.h"
257     *-----------------------------------------------------------------------------
258     * Declaration   : void io_init_dmac(void *src, void *dst, int count);
259     *-----------------------------------------------------------------------------
260     * Description   : Configures the Direct Memory Access Controller (DMAC).
261     *               :  - Operating mode: Cycle steal mode
262     *               :  - On-chip peripheral module request: A/D module_0
263     *               :  - Transfer source: A/D data register_0 (ADDR0)
264     *               :  - Transfer destination: On-chip RAM
265     *               :  - Transfer data length: In words
266     *               :  - Reload function: Not used
267     *-----------------------------------------------------------------------------
268     * Argument      : void *src ; Transfer source address
269     *               : void *dst ; Transfer destination address
270     *               : int count ; Number of transfers
271     *-----------------------------------------------------------------------------
272     * Return Value  : void
273     *-----------------------------------------------------------------------------
274     * Note          : None
275     *""FUNC COMMENT END""*************************************************************/
276    void io_init_dmac(void *src, void *dst, int count)
277    {
278      /* ==== Disables the DMA transfer on channel 0 ==== */
279      DMAC0.CHCR.BIT.DE = 0;
280
281      /* ==== Sets the DMA source address register_0 (SAR_0) ==== */
282      DMAC0.SAR = src;            /* Sets the DMA transfer source address */
283
284      /* ==== Sets the DMA destination address register_0 (DAR_0) ==== */
285      DMAC0.DAR = dst;            /* Sets the DMA transfer destination address */
286
287      /* ==== Sets the DMA transfer count register_0 (DMATCR_0) ==== */
288      DMAC0.DMATCR = count;       /* Sets the number of DMA transfers */
289
290      /* ==== Sets the DMA extension resource selector 0 (DMARS0) ==== */
291      DMAC.DMARS0.WORD =0x00b3;   /* Sets A/D module_0 as the DMA transfer request source */
292
```

3.8 Sample Program List "main.c" (8/9)

```
293      /* ==== Sets the DMA channel control register_0 (CHCR_0) ==== */
294      DMAC0.CHCR.LONG = 0x0000480c;
295        /*
296            bit 31: TC = 0 ------------------ Executes "a transfer" by a transfer request
297            bit 30, 29: Reserved(0)
298            bit 28: RLD = 0 ----------------- Disables the reload function
299            bit 27 to 24: Reserved(0).
300            bit 23: DO = 0 ------------------ Not used
301            bit 22: TL = 0 ------------------ Not used
302            bit 21, 20: Reserved(0)
303            bit 19: HE = 0 ------------------ Not used
304            bit 18: HIE = 0 ----------------- Not used
305            bit 17: AM = 0 ------------------ Not used
306            bit 16: AL = 0 ------------------ Not used
307            bit 15, 14: DM[1:0] = B'01 ------ Increments the destination address by 2
308            bit 13, 12: SM[1:0] = B'00 ------ Specifies the source address as fixed
309            bit 11 to 8: RS[3:0] = B'1000 --- Specifies the DMA extension
310                                              resource selector
311            bit 7: DL = 0 ------------------- Not used
312            bit 6: DS = 0 ------------------- Not used
313            bit 5: TB = 0 ------------------- Specifies cycle steal mode
314            bit 4, 3: TS[1:0] = B'01 -------- Specifies to transfer data in words
315            bit 2: IE = 1 ------------------- Enables the interrupt request
316            bit 1: TE = 0 ------------------- Clears the TE flag
317            bit 0: DE = 0 ------------------- Disables the DMA transfer
318        */
319
320      /* ==== Sets the Interrupt priority register 06 (IPR06) ==== */
321      INTC.IPR06.BIT._DMAC0 = 15;     /* Specifies the DMAC0 interrupt level as 15 */
322
323      /* ==== Sets the DMA operation register (DMAOR) ==== */
324      DMAC.DMAOR.WORD |= 0x0007;
325                  /* bit 0: DME = 1 --- Enables the DMA transfer on all channels */
326                  /* To avoid clearing the address error flag, and  NMI flag, */
327                  /* writes 1 in bits AE and NMIF */
328
329      /* ==== Enables the DMA transfer on channel 0 ==== */
330      DMAC0.CHCR.BIT.DE = 1;
331    }
332
```

3.9 Sample Program List "main.c" (9/9)

```
/*""FUNC COMMENT""*****************************************************************
 * ID            :
 * Outline       : MTU2 Timer Count (TCNT_0) Start Setting
 *-----------------------------------------------------------------------------
 * Include       : "iodefine.h"
 *-----------------------------------------------------------------------------
 * Declaration   : void io_start_timer_mtu2(void);
 *-----------------------------------------------------------------------------
 * Description   : Starts the MTU2 timer counter_0 (TCNT_0) operation.
 *-----------------------------------------------------------------------------
 * Argument      : void
 *-----------------------------------------------------------------------------
 * Return Value  : void
 *-----------------------------------------------------------------------------
 * Note          : None
 *""FUNC COMMENT END""*************************************************************/
void io_start_timer_mtu2(void)
{
  MTU2.TSTR.BIT.CST0 = 1;
}

/* End of File */
```

3.10 Sample Program List "intprg.c" (1/2)

```
1   /***********************************************************************
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3   *
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26  *   http://www.renesas.com/disclaimer
27  ***********************************************************************
28  *   (C) 2010 Renesas Electronics Corporation. All rights reserved.
29  *""FILE COMMENT""*********** Technical reference data *************************
30  *   System Name : SH7216 Sample Program
31  *   File Name   : intprg.c
32  *   Abstract    : Interrupt Functions
33  *   Version     : 1.00.00
34  *   Device      : SH7216
35  *   Tool-Chain  : High-performance Embedded Workshop (Ver.4.07.00).
36  *               : C/C++ compiler package for the SuperH RISC engine family
37  *               :                             (Ver.9.03 Release00).
38  *   OS          : None
39  *   H/W Platform: R0K572167 (CPU board)
40  *   Description :
41  ***********************************************************************
42  *   History     : Jun.03,2010 Ver.1.00.00
43  *""FILE COMMENT END""*****************************************************/
44  #include <machine.h>
45  #include "vect.h"
46  #include "iodefine.h"
47
48  extern unsigned char f_dma_end;
49
```

3.11 Sample Program List "intprg.c" (2/2)

```
50      #pragma section IntPRG
51
52      // 4 Illegal code
53      void INT_Illegal_code(void){/* sleep(); */}
54      // 5 Reserved
55
56      // 6 Illegal slot
57      void INT_Illegal_slot(void){/* sleep(); */}

…       …

260     // 108 DMAC0 DEI0
261     void INT_DMAC0_DEI0(void)
262     {
263       unsigned long dummy;        /* Variable for dummy read */
264
265       f_dma_end = 1;
266
267       /* ==== Stops the MTU2 timer counter (TCNT_0) ==== */
268       MTU2.TSTR.BIT.CST0 = 0;
269
270       /* ==== Disables the DMA transfer on channel 0 ==== */
271       DMAC0.CHCR.BIT.DE = 0;
272
273       /* ==== Clears the DMA transfer end flag ==== */
274       DMAC0.CHCR.BIT.TE = 0;
275
276       dummy = DMAC0.CHCR.LONG;    /* Dummy read */
277     }

…       …

568     // 254 SCIF SCIF3 RXI3
569     void INT_SCIF_SCIF3_RXI3(void){/* sleep(); */}
570     // 255 SCIF SCIF3 TXI3
571     void INT_SCIF_SCIF3_TXI3(void){/* sleep(); */}
572     // Dummy
573     void Dummy(void){/* sleep(); */}
574
575     /* End of File */
```

4. References

- Software Manual
  SH-2A/SH2A-FPU Software Manual Rev.3.00
  The latest version of the software manual can be downloaded from the Renesas Electronics website.

- Hardware Manual
  SH7216 Group Hardware Manual Rev.1.01
  The latest version of the hardware manual can be downloaded from the Renesas Electronics website.

- Technical Update
  Addition to and correction of errors in the SH7280 Group Hardware Manual and SH7216 Group Hardware Manual (TN-SH7-A727A/E)
  Correction of errors in the SH7216 Group Hardware Manual (TN-SH7-A754A/E)
  Correction of errors in the SH7216 Group Hardware Manual (TN-SH7-A761A/E)
  Amendment to Product Code Lineup in the SH7216 Group Hardware Manual (TN-SH7-A762A/E)
  Limitation on Changes to the Frequency Control Register and Correction of Error in the Hardware Manual (TN-SH7-A769A/E)
  Correction of Errors in the Hardware Manual (TN-SH7-A771A/E)
  The latest version can be downloaded from the Renesas Electronics website.

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Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Jun.03.10	—	First edition issued

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins
   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.
   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
2. Processing at Power-on
   The state of the product is undefined at the moment when power is supplied.
   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.
3. Prohibition of Access to Reserved Addresses
   Access to reserved addresses is prohibited.
   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.
4. Clock Signals
   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.
   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
5. Differences between Products
   Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.
   — The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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